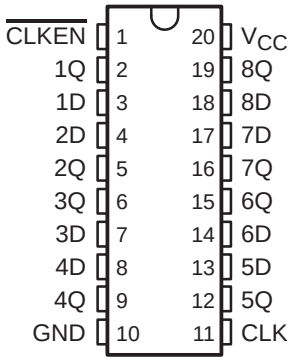
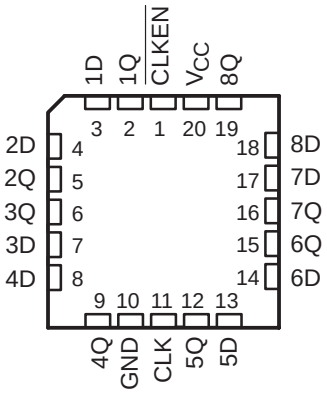
- **Eight Flip-Flops With Single-Rail Outputs**
- **Clock Enable Latched to Avoid False Clocking**
- **Applications Include:**
  - **Buffer/Storage Registers**
  - **Shift Registers**
  - **Pattern Generators**
- **Package Options Include Plastic Small-Outline (DW) and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**

**SN54HC377 . . . J OR W PACKAGE**
**SN74HC377 . . . DW OR N PACKAGE**
**(TOP VIEW)**




**SN54HC377 . . . FK PACKAGE**
**(TOP VIEW)**




## description

These devices are positive-edge-triggered octal D-type flip-flops with an enable input. The ’HC377 are similar to the ’HC273 but feature a latched clock-enable ($\overline{\text{CLKEN}}$) input instead of a common clear.

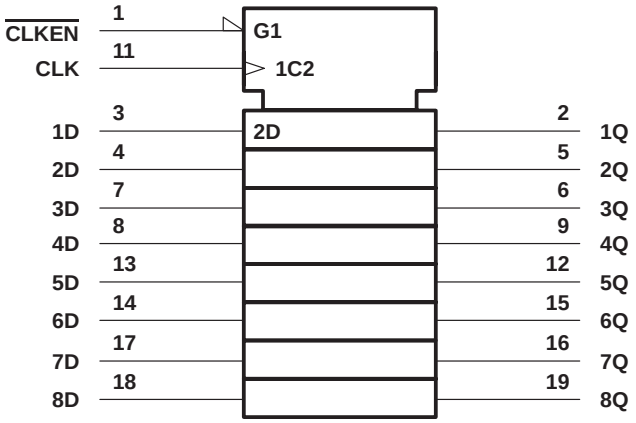
Information at the data (D) inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock (CLK) pulse if $\overline{\text{CLKEN}}$ is low. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When CLK is at either the high or low level, the D input has no effect at the output. These devices are designed to prevent false clocking by transitions at $\overline{\text{CLKEN}}$.

The SN54HC377 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74HC377 is characterized for operation from –40°C to 85°C.

**FUNCTION TABLE**
**(each flip-flop)**

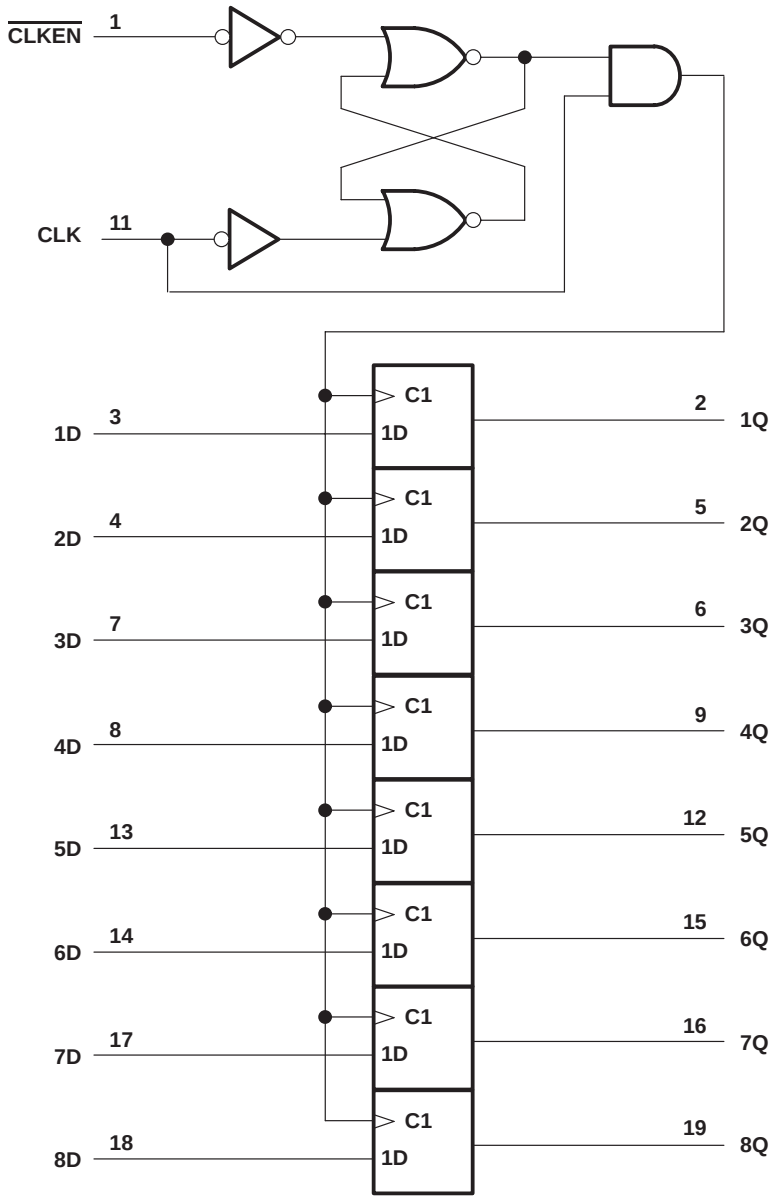
| INPUTS | | | OUTPUT |
|---|---|---|---|
| $\overline{\text{CLKEN}}$ | CLK | D | Q |
| H | X | X | $Q_0$ |
| L | ↑ | H | H |
| L | ↑ | L | L |
| X | L | X | $Q_0$ |

## logic symbol†




† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



### absolute maximum ratings over operating free-air temperature range†

Supply voltage range, $V_{CC}$ . . . . . –0.5 V to 7 V
Input clamp current, $I_{IK}$ ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1) . . . . . ±20 mA
Output clamp current, $I_{OK}$ ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1) . . . . . ±20 mA
Continuous output current, $I_O$ ($V_O = 0$ to $V_{CC}$) . . . . . ±25 mA
Continuous current through $V_{CC}$ or GND . . . . . ±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DW package . . . . . 97°C/W
N package . . . . . 67°C/W
Storage temperature range, $T_{stg}$ . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

### recommended operating conditions

| | | | SN54HC377 | | | SN74HC377 | | | UNIT |
|---|---|---|---|---|---|---|---|---|---|
| | | | MIN | NOM | MAX | MIN | NOM | MAX | |
| $V_{CC}$ | Supply voltage | | 2 | 5 | 6 | 2 | 5 | 6 | V |
| $V_{IH}$ | High-level input voltage | $V_{CC}$ = 2 V | 1.5 | | | 1.5 | | | V |
| | | $V_{CC}$ = 4.5 V | 3.15 | | | 3.15 | | | |
| | | $V_{CC}$ = 6 V | 4.2 | | | 4.2 | | | |
| $V_{IL}$ | Low-level input voltage | $V_{CC}$ = 2 V | 0 | | 0.5 | 0 | | 0.5 | V |
| | | $V_{CC}$ = 4.5 V | 0 | | 1.35 | 0 | | 1.35 | |
| | | $V_{CC}$ = 6 V | 0 | | 1.8 | 0 | | 1.8 | |
| $V_I$ | Input voltage | | 0 | | $V_{CC}$ | 0 | | $V_{CC}$ | V |
| $V_O$ | Output voltage | | 0 | | $V_{CC}$ | 0 | | $V_{CC}$ | V |
| $t_t$ | Input transition (rise and fall) time | $V_{CC}$ = 2 V | 0 | | 1000 | 0 | | 1000 | ns |
| | | $V_{CC}$ = 4.5 V | 0 | | 500 | 0 | | 500 | |
| | | $V_{CC}$ = 6 V | 0 | | 400 | 0 | | 400 | |
| $T_A$ | Operating free-air temperature | | –55 | | 125 | –40 | | 85 | °C |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | $V_{CC}$ | $T_A$ = 25°C | | | SN54HC377 | | SN74HC377 | | UNIT |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| $V_{OH}$ | $V_I = V_{IH}$ or $V_{IL}$ | $I_{OH}$ = –20 μA | 2 V | 1.9 | 1.998 | | 1.9 | | 1.9 | | V |
| | | | 4.5 V | 4.4 | 4.499 | | 4.4 | | 4.4 | | |
| | | | 6 V | 5.9 | 5.999 | | 5.9 | | 5.9 | | |
| | | $I_{OH}$ = –4 mA | 4.5 V | 3.98 | 4.3 | | 3.7 | | 3.84 | | |
| | | $I_{OH}$ = –5.2 mA | 6 V | 5.48 | 5.8 | | 5.2 | | 5.34 | | |
| $V_{OL}$ | $V_I = V_{IH}$ or $V_{IL}$ | $I_{OL}$ = 20 μA | 2 V | | 0.002 | 0.1 | | 0.1 | | 0.1 | V |
| | | | 4.5 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | |
| | | | 6 V | | 0.001 | 0.1 | | 0.1 | | 0.1 | |
| | | $I_{OL}$ = 4 mA | 4.5 V | | 0.17 | 0.26 | | 0.4 | | 0.33 | |
| | | $I_{OL}$ = 5.2 mA | 6 V | | 0.15 | 0.26 | | 0.4 | | 0.33 | |
| $I_I$ | $V_I = V_{CC}$ or 0 | | 6 V | | | ±0.1 | ±100 | | ±1000 | | ±1000 | nA |
| $I_{CC}$ | $V_I = V_{CC}$ or 0, $I_O$ = 0 | | 6 V | | | | 8 | | 160 | | 80 | μA |
| $C_i$ | | | 2 V to 6 V | | 3 | 10 | | 10 | | 10 | pF |

## timing requirements over recommended operating free-air temperature range (unless otherwise noted)

| | | | $V_{CC}$ | $T_A$ = 25°C | | SN54HC377 | | SN74HC377 | | UNIT |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| $f_{clock}$ | Clock frequency | | 2 V | 0 | 5 | 0 | 3 | 0 | 4 | MHz |
| | | | 4.5 V | 0 | 25 | 0 | 16 | 0 | 20 | |
| | | | 6 V | 0 | 29 | 0 | 19 | 0 | 23 | |
| $t_w$ | Pulse duration, CLK high or low | | 2 V | 100 | | 150 | | 125 | | ns |
| | | | 4.5 V | 20 | | 30 | | 25 | | |
| | | | 6 V | 17 | | 25 | | 21 | | |
| $t_{su}$ | Setup time before CLK↑ | D | 2 V | 100 | | 150 | | 125 | | ns |
| | | | 4.5 V | 20 | | 30 | | 25 | | |
| | | | 6 V | 17 | | 25 | | 21 | | |
| | | $\overline{CLKEN}$ high or low | 2 V | 100 | | 150 | | 125 | | |
| | | | 4.5 V | 20 | | 30 | | 25 | | |
| | | | 6 V | 17 | | 25 | | 21 | | |
| $t_h$ | Hold time after CLK↑ | $\overline{CLKEN}$ inactive or active, data | 2 V | 5 | | 5 | | 5 | | ns |
| | | | 4.5 V | 5 | | 5 | | 5 | | |
| | | | 6 V | 5 | | 5 | | 5 | | |

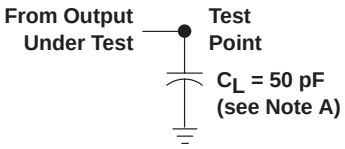
**switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)**

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC}$ | $T_A$ = 25°C | | | SN54HC377 | | SN74HC377 | | UNIT |
|---|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| $f_{max}$ | | | 2 V | 5 | 11 | | 3 | | 4 | | MHz |
| | | | 4.5 V | 25 | 54 | | 16 | | 20 | | |
| | | | 6 V | 29 | 64 | | 19 | | 23 | | |
| $t_{pd}$ | CLK | Any | 2 V | | 56 | 160 | | 240 | | 200 | ns |
| | | | 4.5 V | | 15 | 32 | | 48 | | 40 | |
| | | | 6 V | | 12 | 27 | | 41 | | 34 | |
| $t_t$ | | Any | 2 V | | 38 | 75 | | 110 | | 95 | ns |
| | | | 4.5 V | | 8 | 15 | | 22 | | 19 | |
| | | | 6 V | | 6 | 13 | | 19 | | 16 | |

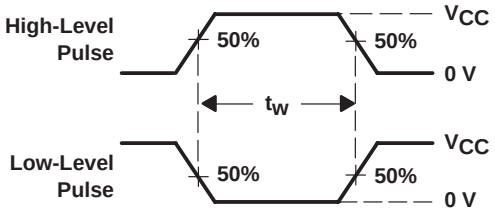
**operating characteristics, $T_A$ = 25°C**

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|---|---|---|---|---|
| $C_{pd}$ | Power dissipation capacitance per flip-flop | No load | 30 | pF |

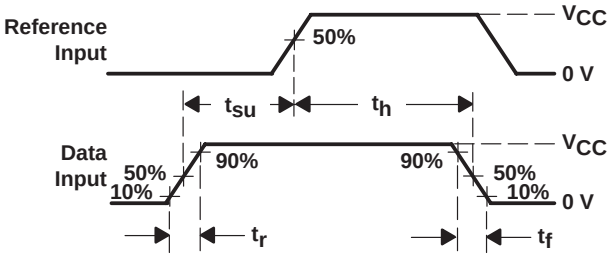
## PARAMETER MEASUREMENT INFORMATION



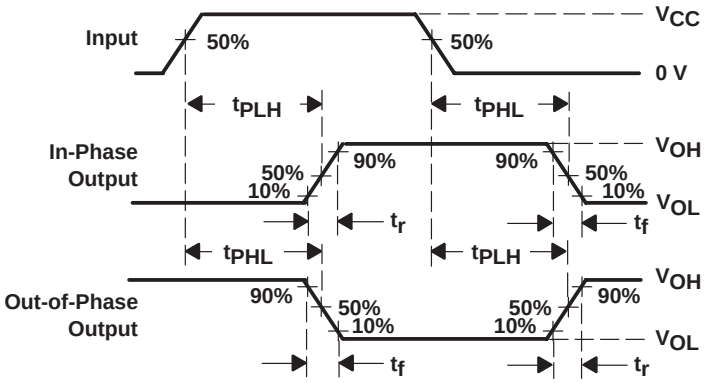

LOAD CIRCUIT




VOLTAGE WAVEFORMS
PULSE DURATIONS




VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES




VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES

NOTES: A. $C_L$ includes probe and test-fixture capacitance.
B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O$ = 50 Ω, $t_r$ = 6 ns, $t_f$ = 6 ns.
C. For clock inputs, $f_{max}$ is measured when the input duty cycle is 50%.
D. The outputs are measured one at a time with one input transition per measurement.
E. $t_{PLH}$ and $t_{PHL}$ are the same as $t_{pd}$.

**Figure 1. Load Circuit and Voltage Waveforms**

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